

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSII)

## 2SK3236

Switching Regulator Applications, DC-DC Converter and Motor Drive Applications

- 4 V gate drive
- Low drain-source ON resistance:  $R_{DS(ON)} = 13.5 \text{ m}\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 42 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = 100 \text{ }\mu\text{A}$  (max) ( $V_{DS} = 60 \text{ V}$ )
- Enhancement-model:  $V_{th} = 1.3\sim 2.5 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_D = 1 \text{ mA}$ )

### Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	60	V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	60	V
Gate-source voltage		$V_{GSS}$	$\pm 20$	V
Drain current	DC (Note 1)	$I_D$	35	A
	Pulse (Note 1)	$I_{DP}$	105	
Drain power dissipation ( $T_c = 25^\circ\text{C}$ )		$P_D$	30	W
Single pulse avalanche energy (Note 2)		$E_{AS}$	68	mJ
Avalanche current		$I_{AR}$	35	A
Repetitive avalanche energy (Note 3)		$E_{AR}$	3.0	mJ
Channel temperature		$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	$-55\sim 150$	$^\circ\text{C}$

### Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	4.16	$^\circ\text{C/W}$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	62.5	$^\circ\text{C/W}$

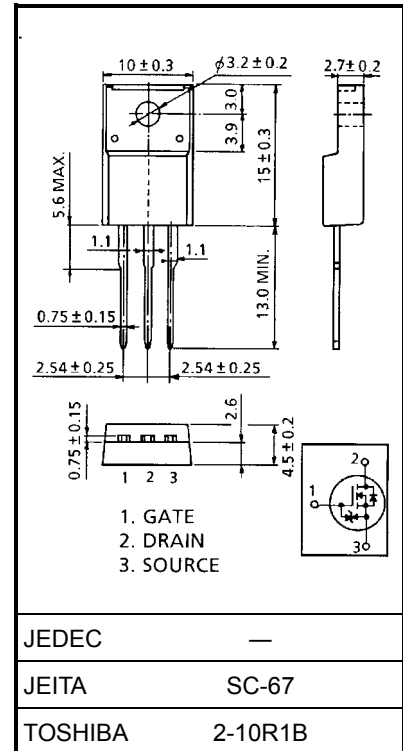
Note 1: Please use devices on condition that the channel temperature is below  $150^\circ\text{C}$ .

Note 2:  $V_{DD} = 50 \text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$ ,  $L = 40 \text{ }\mu\text{H}$ ,  $R_G = 25 \text{ }\Omega$ ,  $I_{AR} = 35 \text{ A}$

Note 3: Repetitive rating; pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device. Please handle with caution

Unit: mm



Weight: 1.9 g (typ.)

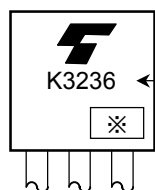
## Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain cut-OFF current		$I_{DSS}$	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	60	—	—	V
Gate threshold voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	1.3	—	2.5	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 4\text{ V}, I_D = 18\text{ A}$	—	22	36	m $\Omega$
			$V_{GS} = 10\text{ V}, I_D = 18\text{ A}$	—	13.5	20	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 18\text{ A}$	21	42	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	2300	—	pF
Reverse transfer capacitance		$C_{rss}$		—	220	—	
Output capacitance		$C_{oss}$		—	370	—	
Switching time	Rise time	$t_r$	<p><math>V_{GS} = 10\text{ V}, 0\text{ V}</math>  <math>I_D = 18\text{ A}</math>  <math>R_L = 1.67\ \Omega</math>  <math>V_{DD} \approx 30\text{ V}</math>  <math>4.7\ \Omega</math>  <math>V_{OUT}</math>                      Duty <math>\leq 1\%</math>, <math>t_w = 10\ \mu\text{s}</math></p>	—	9	—	ns
	Turn-ON time	$t_{on}$		—	23	—	
	Fall time	$t_f$		—	20	—	
	Turn-OFF time	$t_{off}$		—	100	—	
Total gate charge (gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 48\text{ V}, V_{GS} = 10\text{ V}, I_D = 35\text{ A}$	—	52	—	nC
Gate-source charge		$Q_{gs}$		—	37	—	
Gate-drain ("miller") charge		$Q_{gd}$		—	15	—	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	—	—	—	35	A
Pulse drain reverse current (Note 1)	$I_{DRP}$	—	—	—	105	A
Forward voltage (diode)	$V_{DSF}$	$I_{DR} = 35\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 35\text{ A}, V_{GS} = 0\text{ V},$	—	60	—	ns
Reverse recovery charge	$Q_{rr}$	$dI_{DR}/dt = 50\text{ A}/\mu\text{s}$	—	81	—	nC

## Marking

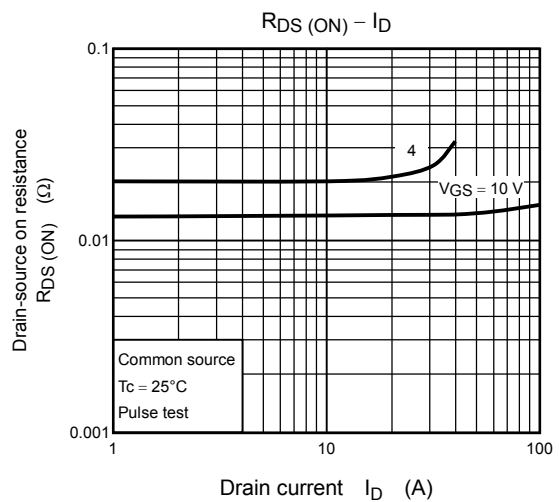
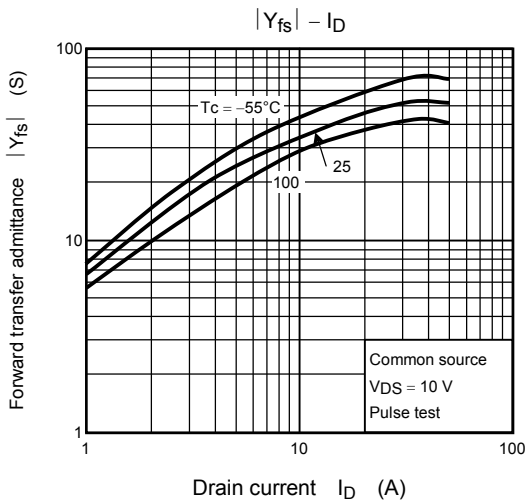
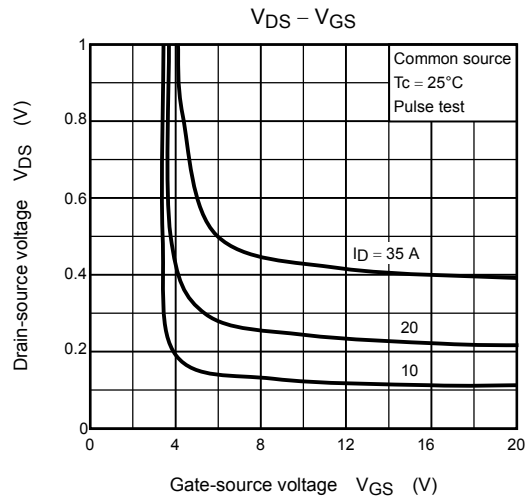
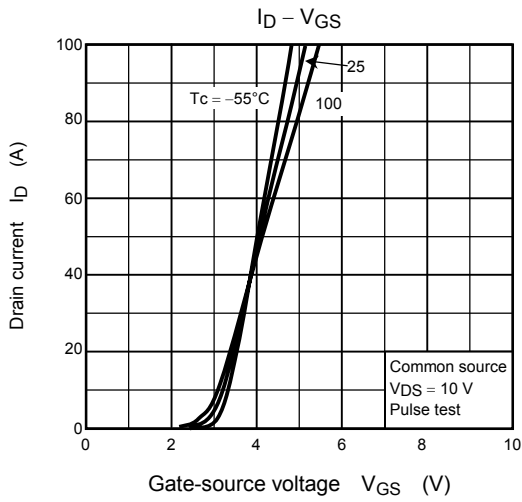
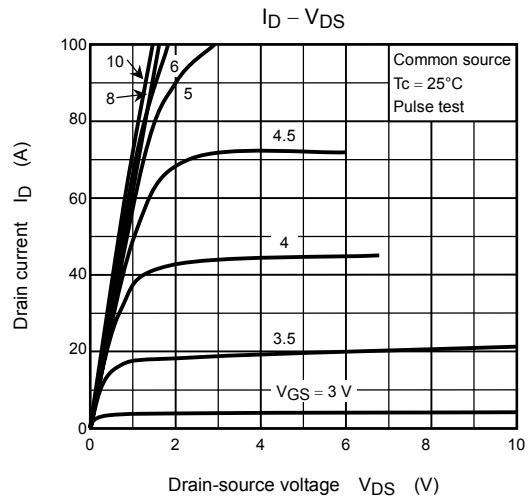
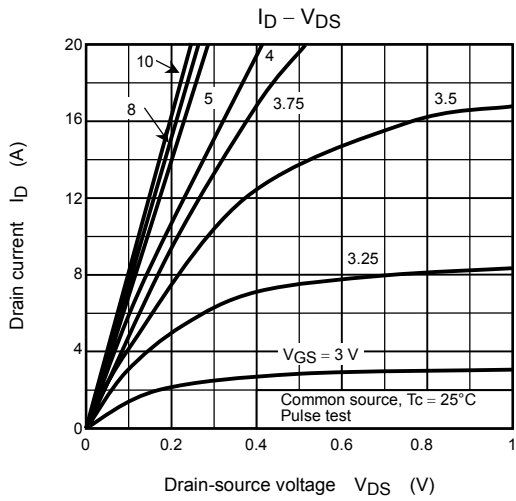


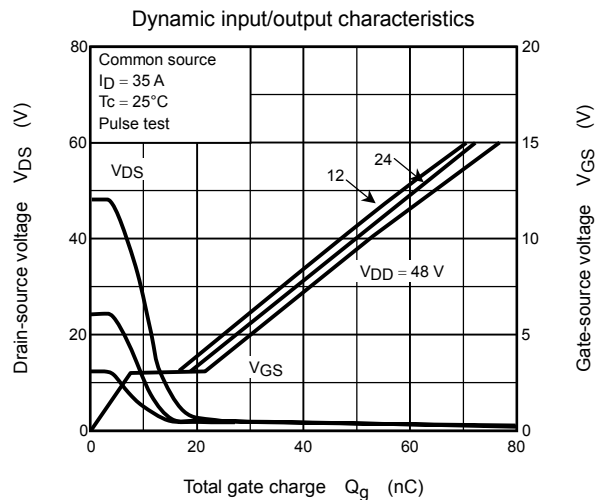
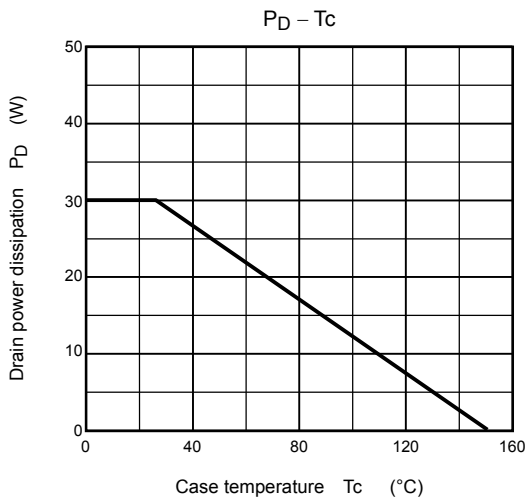
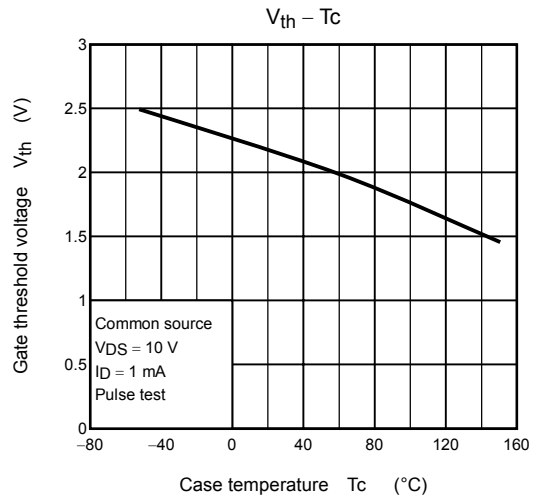
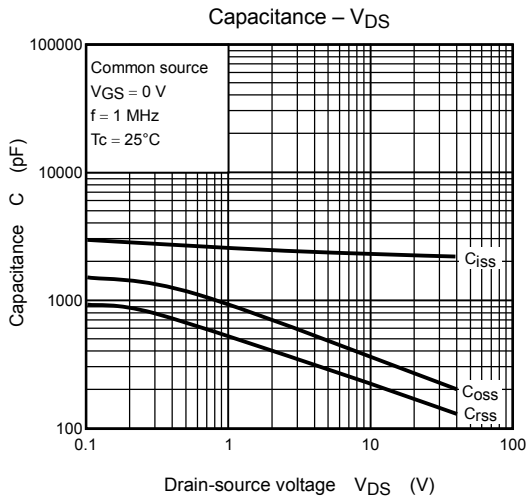
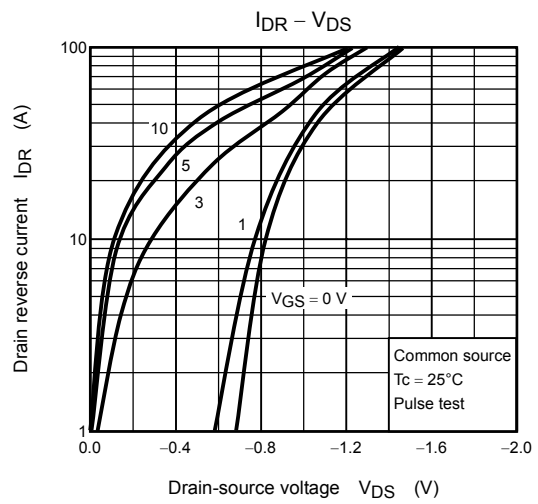
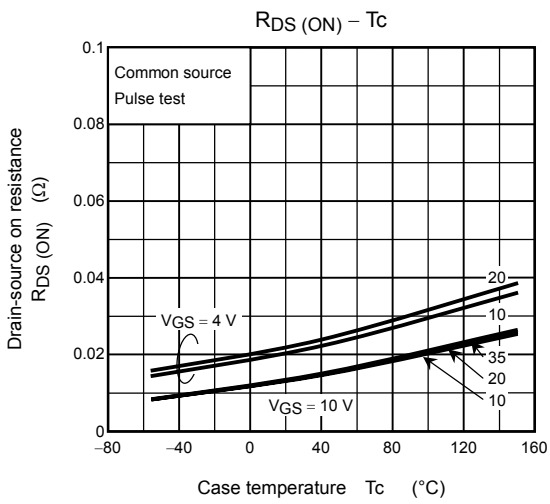
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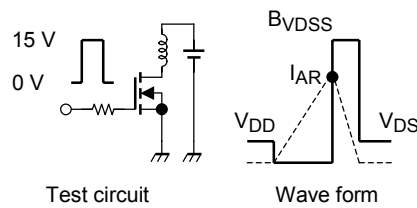
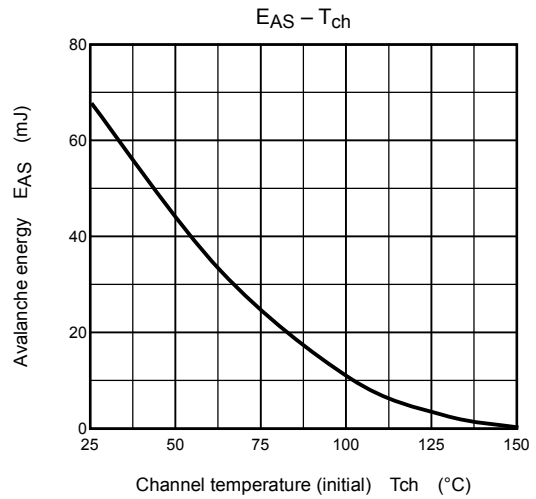
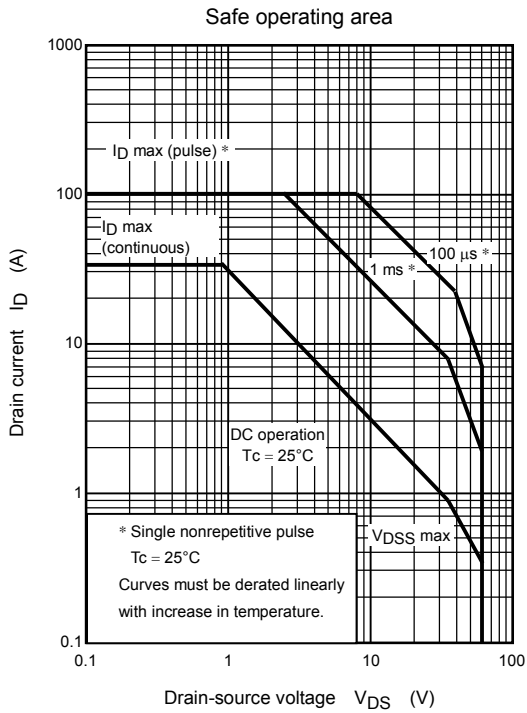
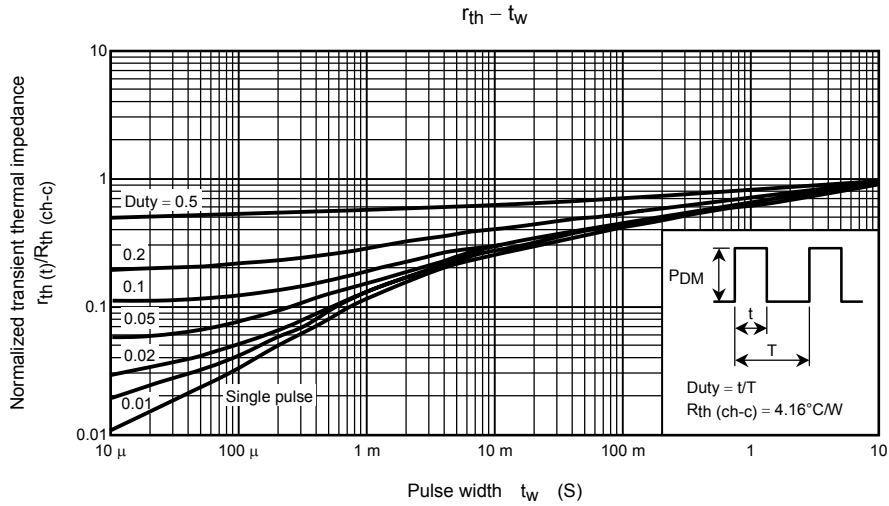
※ Lot Number

□ □ ← Month (starting from alphabet A)

□ ← Year (last number of the christian era)







$$R_G = 25 \Omega$$

$$V_{DD} = 50 \text{ V}, L = 40 \mu\text{H}$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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